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<p>(21) International Application Number: PCT/US96/00985 (22) International Filing Date: 24 January 1996 (24.01.96) (30) Priority Data: 08/388,948 15 February 1995 (15.02.95) US (71) Applicant: THE PROCTER &amp; GAMBLE COMPANY [US/US]; One Procter &amp; Gamble Plaza, Cincinnati, OH 45202 (US). (72) Inventors: TROKHAN, Paul, Dennis; 1356 Warvel Road, Hamilton, OH 45013 (US). POWERS, John, Robert; 5743 Chesterfield Court, Fairfield, OH 45014 (US). MILLER, James, Daniel, II; 4108 Benkert Drive, Cincinnati, OH 45241 (US). BOUTILIER, Glenn, David; 10566 Stablehand Drive, Cincinnati, OH 45242 (US). McFARLAND, James, Robert; Apartment 13, 2508 Auburn Avenue, Cincinnati, OH 45219 (US). (74) Agents: REED, T., David et al.; The Procter &amp; Gamble Company, 5299 Spring Grove Avenue, Cincinnati, OH 45217 (US).</p>	<p>(81) Designated States: AL, AM, AT, AU, AZ, BB, BG, BR, BY, CA, CH, CN, CZ, DE, DK, EE, ES, FI, GB, GE, HU, IS, JP, KE, KG, KP, KR, KZ, LK, LR, LS, LT, LU, LV, MD, MG, MK, MN, MW, MX, NO, NZ, PL, PT, RO, RU, SD, SE, SG, SI, SK, TJ, TM, TR, TT, UA, UG, UZ, VN, ARIPO patent (KE, LS, MW, SD, SZ, UG), Eurasian patent (AZ, BY, KG, KZ, RU, TJ, TM), European patent (AT, BE, CH, DE, DK, ES, FR, GB, GR, IE, IT, LU, MC, NL, PT, SE), OAPI patent (BF, BJ, CF, CG, CI, CM, GA, GN, ML, MR, NE, SN, TD, TG).</p> <p><b>Published</b> <i>With international search report. Before the expiration of the time limit for amending the claims and to be republished in the event of the receipt of amendments.</i></p>	
<p>(54) Title: METHOD OF APPLYING A PHOTSENSITIVE RESIN TO A SUBSTRATE FOR USE IN PAPERMAKING</p>		
<p>(57) Abstract</p> <p>The invention comprises a method for applying a curable resin, such as a photosensitive resin, to a substrate such as a papermaker's dewatering felt. The method comprises the steps of providing a substrate; providing a curable liquid resin; providing a second material different from the curable liquid resin; applying the second material to the substrate to occupy at least some of the voids in the substrate intermediate the first and second surfaces of the substrate; applying the curable resin to the substrate; curing at least some of the resin to provide a resin layer on the substrate; and removing at least some of the second material from the substrate, wherein at least some of the second material is removed from the substrate after applying the curable resin to the substrate.</p>		

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METHOD OF APPLYING A PHOTSENSITIVE RESIN  
TO A SUBSTRATE FOR USE IN PAPERMAKING

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FIELD OF THE INVENTION

The present invention provides a method for applying a curable resin to a substrate, and more particularly, to a method of applying a photosensitive resin to a substrate to form a web patterning apparatus for use in papermaking.

BACKGROUND OF THE INVENTION

The application of coatings, such as resin coatings and foam coatings to substrates is known in the papermaking art. For instance, it is known to apply a photosensitive resin to a foraminous member in a preselected pattern for use in a papermaking operation. It is also known to provide papermaking press fabrics with a coating, such as a foam coating, to achieve a controlled void volume and permeability. The following documents describe the use of resins, fillers, foams, layered constructions, or other coatings in making papermaking equipment: U.S. Patent 3,549,742 issued December 22, 1970 to Benz; U.S. Patent 4,446,187 to Eklund; U.S. Patent 4,514,345 issued April 30, 1985 to Johnson et al.; U.S. Patent 4,637,859 issued January 20, 1987 to Trokhan; U.S. Patent 4,795,480 issued January 3 1989 to Boyer et al.; U.S. Patent 5,098,522 issued March 24, 1992 to Smurkoski et al.; U.S. Patent 5,346,567 issued September 13, 1994 to Barnewall; U.S. Patent 5,334,289 issued August 2, 1994 to Trokhan et al.; and PCT Publication Number WO 91/14558 published October 3, 1991 in the name of Sayers et al. and assigned to the SCAPA Group.

5           It is also known to impregnate textile fabrics, such as needled fiber mats and felt material, with resins and filler materials. The following documents describe the use of resins and/or fillers in fabrics: U.S. Patent 4,250,172 to Mutzenberg et al; U.S. Patent 4,390,574 to Wood; U.S. Patent 4,464,432 to Dost et al.; U.S. Patent 5,217,799 to Sumii et al.; U.S. Patent 5,236,778 to Landis et al.; and Reissue Patent  
10 32,713 reissued July 12, 1988 to Woo.

          After curing a portion of the resin on a substrate to form a papermaking apparatus, it is desirable to remove uncured resin from the substrate. Removal of uncured resin from the substrate is important so that the resulting papermaking apparatus has the desired characteristics for its particular papermaking application.  
15 Such characteristics can include, but are not limited to, flexibility of the apparatus, compressibility of the apparatus, air permeability through the apparatus, and water permeability through the apparatus. Removal of uncured resin is especially important in a papermaking apparatus having a patterned resin surface with openings through which air and/or water is conveyed during formation or drying of the paper  
20 web. Uncured resin remaining in the substrate can reduce the permeability of the substrate, and thereby reduce flow through the openings in the patterned resin surface.

          One method for removing uncured resin includes washing uncured resin from the substrate. For instance, above referenced U.S. Patent 4,514,345 discloses  
25 washing uncured resin from a foraminous member formed of woven filaments, followed by vacuuming of residual wash liquid and uncured liquid from the foraminous member. However, washing and vacuuming, alone, can be ineffective in removing all uncured resin.

          A felt or open celled foam substrate can have a large number of relatively  
30 small, internal void cavities which can trap uncured resin. Such trapped uncured resin can degrade the performance of the papermaking apparatus, as described above. In addition, such trapped resin is essentially wasted, adding to the cost of the resin casting process. Removal of the trapped resin by increasing the number of washing and vacuum cycles also increases the cost of the process.

35           Moreover, in some applications it may be desirable to control the depth of penetration of the resin into the substrate. For instance, it may be desirable to have the cured resin layer penetrate a predetermined portion of the thickness of the substrate, so as to provide acceptable bonding of the resin to the substrate, while maintaining the flexibility of the substrate and the permeability of the substrate to air  
40 and water.

5 U.S. Patent 3,549,742 issued December 22, 1970 to Benz discloses inserting  
filling material into apertures in a drainage member which will ultimately be open for  
drainage, after which a settable material is inserted into the remaining apertures of  
the drainage member in the predetermined areas in which flow of liquid through the  
10 drainage member is to be prevented. The settable material is fixed or cured, after  
which the filling material is removed from the drainage member. Benz has the  
disadvantage that the filler material is arranged in a predetermined pattern prior to  
application to the drainage member, and the filler material must be pressed into the  
drainage member such that predetermined areas of the drainage member member are  
15 left free of the filling material. Accordingly, the pattern in which the settable  
material can be fixed to the drainage member is limited by the predetermined areas of  
the drainage member left free of the filling material.

Also, Benz uses pressure to mechanically force the filler material into the  
drainage member. Pressing a filling material into a substrate can suffer from the  
20 disadvantage that, if the substrate has many small internal voids, and is relatively  
compressible, applying pressure to the substrate can collapse the substrate or close  
some of the voids in the substrate, thereby making penetration of the substrate by the  
filler material difficult.

In addition, pressing a filling material into a felt layer can result in the filling  
material flowing laterally into areas of the felt which are meant to be left open for the  
25 settable material. Therefore, the method disclosed by Benz is undesirable for use in  
applying a curable resin to a felt layer.

Accordingly, one object of the present invention is to provide a method of  
applying a curable resin to a substrate to form a papermaking apparatus.

Another object of the invention is to provide a method for reducing the  
30 amount of uncured photosensitive resin that is required to be removed from a paper  
web patterning apparatus suitable for making paper having visually discernible  
patterns.

Another object is to provide a method for forming a web patterning apparatus  
having a dewatering felt layer and a patterned photosensitive resin layer which  
35 penetrates a surface of the felt layer and extends from the surface of the felt layer.

### SUMMARY OF THE INVENTION

The invention comprises a method of applying a curable resin to a substrate.  
In particular, the method can be used to form a papermaking apparatus such as a  
40 paper web forming fabric or a paper web drying fabric. In one embodiment, the  
method of the present invention can be used to apply a photosensitive resin to a

5 dewatering felt layer to provide a papermaking apparatus that can be used to pattern  
and dewater a paper web. The resulting papermaking apparatus can comprise a  
dewatering felt layer having a first web facing felt surface at a first elevation and a  
second oppositely facing felt surface, and a web patterning layer comprising the  
photosensitive resin. The patterning layer penetrates the first felt surface, and  
10 extends from the first felt surface to form a web contacting top surface at a second  
elevation different from the elevation of the first felt surface.

The method according to the present invention provides a barrier in the  
substrate to restrict the depth to which the curable liquid resin can penetrate through  
the thickness of the substrate. The method comprises the steps of:

15 providing a substrate having a first surface, a second surface, and a thickness,  
the substrate having voids intermediate the first and second surfaces;  
providing a curable liquid resin;  
providing a second material different from the curable liquid resin;  
applying the second material to the substrate to occupy at least some of the  
20 voids in the substrate intermediate the first and second surfaces of the substrate;  
applying the curable resin to the substrate;  
curing at least some of the resin to provide a resin layer on the substrate; and  
removing at least some of the second material from the substrate, wherein at  
least some of the second material is removed from the substrate after applying the  
25 curable resin to the substrate.

The step of removing at least some of the second material preferably  
comprises removing at least about 50 percent of the second material applied to the  
substrate, and more preferably, removing substantially all of the second material  
applied to the substrate.

30 In one embodiment the substrate comprises a papermaker's dewatering felt,  
and the resin comprises a photosensitive resin.

In one embodiment, the method includes the steps of reducing the mobility of  
the second material applied to the substrate prior to applying the resin to the  
substrate. The method can also include the step of increasing the mobility of the  
35 second material after curing at least some of the resin, to thereby facilitate removal  
of the second material from the substrate.

In one embodiment, the method can include the step of changing the phase of  
the second material applied to the substrate prior to applying the liquid  
photosensitive resin. In one embodiment the second material is applied throughout  
40 the thickness of the substrate as a liquid mixture of water and a soap gelling agent.  
The second material is cooled to harden the second material to a gel phase. A thin

5 layer of the gelled second material adjacent to the first surface of the substrate is liquified or solubilized for removal by water showering to provide a portion of the thickness of the substrate adjacent to the first surface which is substantially free of the second material.

10 The liquid photosensitive resin can then be applied to the first surface of the substrate to penetrate into the substrate from the first surface, and to extend outward of the substrate a predetermined distance from the first surface. A source of actinic radiation and a mask having opaque and transparent regions are provided. The liquid photosensitive resin is cured in a predetermined pattern by exposing the resin to the actinic radiation through the mask. Uncured liquid resin can then be washed  
15 from the first surface of the substrate with water showering. The gelled second material remaining in the substrate is then liquified and removed from the substrate by heating, hot water showering and vacuuming.

#### DESCRIPTION OF THE DRAWINGS

20 While the Specification concludes with claims particularly pointing out and distinctly claiming the present invention, the invention will be better understood from the following description taken in conjunction with the associated drawings, in which like elements are designated by the same reference numeral, and:

25 Figure 1 is a plan view illustration of an apparatus made according to the method of the present invention, the apparatus including a dewatering felt layer and a cured photosensitive resin web patterning layer joined to the dewatering felt layer and having a continuous network web contacting top surface.

Figure 2 is a cross-sectional illustration of the apparatus in Figure 1.

30 Figure 3 is an illustration of a process for making paper with a web patterning apparatus made according to the method of the present invention.

Figures 4A-4H are schematic illustrations of steps for making a web patterning apparatus according to the method of the present invention.

35 Figure 5 is a schematic illustration of a method according to the present invention for making a web patterning apparatus having a felt dewatering layer and a web patterning layer formed from photosensitive resin.

Figure 6 is a photomicrograph of an apparatus made according to the method of the present invention.

40 Figure 7 is a photomicrograph of a cross-section of the apparatus of Figure 6.





5 the first felt surface 230, as shown in Figure 1. Alternatively, the web patterning layer can be discontinuous, or semicontinuous.

The web patterning layer 250 comprises a curable resin which can be deposited on a surface of a substrate as a liquid, and subsequently cured so that a portion of the web patterning layer penetrates a surface of the substrate. In particular, the web  
10 patterning layer 250 can comprise a photosensitive resin which can be deposited on the first surface 230 as a liquid and subsequently cured by radiation so that a portion of the web patterning layer 250 penetrates, and is thereby securely bonded to, the first felt surface 230. The web patterning layer 250 preferably does not extend through the entire thickness of the felt layer 220, but instead extends through less  
15 than about half the thickness of the felt layer 220 to maintain the flexibility and compressibility of the web support apparatus 200, and particularly the flexibility and compressibility of the felt layer 220.

A suitable dewatering felt layer 220 comprises a batt 240 of natural or synthetic fibers joined, such as by needling, to a support structure formed of woven  
20 filaments 244, as shown in Figure 4A. Suitable materials from which the batt 240 is formed include but are not limited to natural fibers such as wool and synthetic fibers such as polyester and nylon. The fibers from which the batt 240 is formed can have a denier of between about 1 and 20 grams per 9000 meters of filament length.

The felt layer 220 can have a layered construction, and can comprise a mixture  
25 of fiber types and sizes. The felt layer 220 can have finer, relatively densely packed fibers disposed adjacent the first felt surface 230. In one embodiment, the felt layer 220 can have a relatively high density and relatively small pore size adjacent the first felt surface 230 as compared to the density and pore size of the felt layer 220 adjacent the second felt surface 232.

30 The dewatering felt layer 220 can have a thickness of between about 2 millimeters and about 5 millimeters, a basis weight of between about 800 and about 2000 grams per square meter, an average density (basis weight divided by thickness) of between about 0.16 gram per cubic centimeter and about 1.0 gram per cubic centimeter, and an air permeability of between about 5 and about 300 standard cubic  
35 feet per minute (scfm), where the air permeability in scfm is a measure of the number of cubic feet of air per minute that pass through a one square foot area of the felt layer 220 at a pressure drop across the thickness of the felt layer 220 equal to about 0.5 inch of water. The air permeability is measured using a Valmet permeability measuring device (Model Wigo Taifun Type 1000) available from the Valmet Corp.  
40 of Pansio, Finland. The permeability of the web support apparatus 200 is less than or equal to the permeability of the felt layer 220 and is about equal to the

5 permeability of the felt layer 220 multiplied by the fraction of the projected area of the apparatus 200 not covered by the web patterning layer 250.

A suitable felt layer 220 is an Amflex 2 Press Felt manufactured by the Appleton Mills Company of Appleton, Wisconsin. Such a felt layer 220 can have a thickness of about 3 millimeter, a basis weight of about 1400 gm/square meter, an air  
10 permeability of about 20 to 30 scfm, and have a double layer support structure having a 3 ply multifilament top and bottom warp and a 4 ply cabled monofilament cross-machine direction weave. The batt 240 can comprise nylon fibers having a denier of about 3 at the first surface 230, and denier of between about 10-15 in the batt substrate underlying the first surface 230.

15 Suitable photosensitive resins are disclosed in U.S. Patent 4,514,345 issued April 30 1985 to Johnson et al. and U.S. Patent 5,334,289 issued August 2, 1994 to Trokhan et al., which patents are incorporated herein by reference. The resin, when cured, can have a hardness of less than or equal to about 60 Shore D. The hardness is the average of five measurements on an unpatterned photopolymer resin coupon  
20 measuring about 1 inch by 2 inches by 0.025 inches thick cured under the same conditions as the web patterning layer 250. The hardness measurements are made at 25 degrees Centigrade and read 10 seconds after initial engagement of the Shore D durometer probe with the resin. A resin having such a hardness upon curing is desirable so that the web patterning layer 250 is somewhat flexible and deformable.  
25 The cured resin preferably resists oxidation. The uncured resin can have viscosity of between about 5000 and about 25000 centipoise at 70 degrees Fahrenheit to facilitate penetration of felt layer 220 by the resin prior to curing. Suitable liquid photosensitive resins included in the Merigraph series of resins made by Hercules, Inc. of Wilmington, Delaware incorporating an antioxidant as disclosed in above  
30 referenced U.S. Patent 5,334,289. A suitable liquid photosensitive resin is a MEH-1000 resin available from Hercules, Inc.

#### Use of the Web Support Apparatus to Make Paper

Figure 3 illustrates use of the apparatus 200 in making a paper web 20. A  
35 slurry of papermaking fibers, such as cellulosic wood pulp fibers, is deposited from a headbox 500 onto a foraminous, liquid pervious forming belt 542, to form an embryonic web of papermaking fibers 543 supported by the forming belt 542. The forming belt 542 can comprise a continuous Fourdrinier wire, or alternatively, can be in the form of any of the various twin wire formers known in the art. The web 543 is  
40 then transferred from the forming belt 542 to the web support apparatus 200, with

5 the embryonic web 543 positioned on the first side 202 of the web support apparatus 200.

The step of transferring the embryonic web 543 to the web support apparatus 200 can simultaneously include the step of deflecting a portion of the web 543 into openings 270 in the web patterning layer 250 to form a non-monoplanar web 545.  
10 The steps of transferring the embryonic web 543 to the web support apparatus 200 and deflecting a portion of the embryonic web 543 can be provided, at least in part, by applying a differential fluid pressure to the embryonic web 543 by a vacuum source 600. One or more additional vacuum sources 620 can also be provided downstream of the embryonic web transfer point.

15 After transferring and deflecting the embryonic web 543 to form the non-monoplanar web 545, the web 545 is carried on the web support apparatus 200 through a nip 800 provided between a yankee drying drum 880 and a roller 900. The web is transferred to and dried on the surface 875 of the drum 880, and then creped from the surface 880 by a doctor blade 1000 to form a creped paper web 20.  
20 Prior to transferring the web 545 to the drying drum 880, the web can be further dewatered, such as by pressing or by through air drying. For instance, the web can be pressed in a press nip 700 between the web support apparatus 200 and a separate dewatering felt 712, as is disclosed in U.S. Patent Application Serial Number 08/358,661 "Wet Pressed Paper Web and Method of Making the Same" filed  
25 December 19, 1994 in the name of Ampulski et al. The following patent documents are incorporated herein by reference in their entirety for the purpose of disclosing how to make a patterned web 20: U.S. Patent 4,529,480 issued July 16, 1985 to Trokhan; U.S. Patent Application Serial Number 08/268,154 "Web Patterning Apparatus Comprising a Felt Layer and a Photosensitive Resin Layer" filed June 29,  
30 1994 in the Name of Trokhan et al.; U.S. Patent Application Serial Number 08/268,213 "Paper Structures Having at Least Three Regions Including a Transition Region Interconnecting Relatively Thinner Regions disposed at Different Elevations, and Apparatus and Process for Making the Same" filed June 29, 1994 in the name of Trokhan et al.; and U.S. Patent Application Serial Number 08/358,661  
35 "Wet Pressed Paper Web and Method of Making the Same" filed December 19, 1994 in the name of Ampulski et al.

#### Making a Paper Web Support Apparatus with Photosensitive Resin Cured on a Felt Layer

40 The web support apparatus 200 can be made according to the present invention using steps illustrated in Figures 4A-4H. A substrate is provided having a

5 first surface, a second surface, and a thickness, with the substrate having voids intermediate the first and second surfaces. In Figure 4A the substrate provided is a dewatering felt layer 220. A liquid photosensitive resin and a second material different from the photosensitive resin are also provided.

Referring to Figure 4B, the present invention includes the step of applying the  
10 second material, designated by numeral 2000, to the felt layer 220. The felt layer 220 is conveyed in the direction shown by the arrow in Figure 4B. In one embodiment, the felt layer 220 can be conveyed adjacent an infrared heating lamp 2310 positioned adjacent the first felt surface 230 of the felt layer 220 prior to applying the second material to the felt layer 220. The heating lamp 2310 can be  
15 used to warm the felt layer 220. Use of the heating lamp 2310 is optional, and not required.

The felt layer 220 can then be conveyed adjacent a header pipe 2410 positioned adjacent to the second surface 232 of the felt layer 220. The header pipe 2410 has an opening through which the second material 2000 is directed onto the  
20 second surface 232 of the felt layer 220. The second material is applied as a liquid to the felt layer 220 to occupy at least some voids in the felt layer intermediate the surfaces 230 and 232. In Figure 4B, the second material is applied to the felt layer 200 to penetrate the entire thickness of the felt layer between the surfaces 230 and 232. The felt layer 220 on which the second material 2000 has been deposited is  
25 directed through a nip 2470 between rollers 2472 to ensure that the second material is distributed throughout the entire thickness of the felt layer 220 between the surfaces 230 and 232. Alternatively, the second material 2000 can be applied to the first surface 230 of the felt layer 220.

The second material 2000 fills voids in felt layer 220, and thereby provides a  
30 barrier to penetration of the liquid photosensitive resin throughout the felt layer 220. The second material 2000 serves to prevent the curable resin from entering certain target portions of the void-containing felt layer 220. The second material is preferably easily applied to the substrate, and is preferably not displaced from the felt layer 220 by the curable resin. The second material is also preferably easily removed  
35 from the felt layer 220 after curing of the resin applied to the felt layer 220.

In one embodiment, the second material 2000 (1) can be applied to the felt layer 220 in a relatively mobile state to provide penetration of the second material 2000 throughout the felt layer 220; (2) can be altered after it is applied to the felt layer and before application of the photosensitive resin to the felt layer 220 to have a  
40 reduced mobility to thereby resist displacement of the second material 2000 by the photosensitive resin; and (3) can be altered to have an increased mobility after at

5 least partially curing the resin to facilitate removal of the second material from the voids in the felt layer 220.

In one embodiment, the second material is relatively mobile when first applied to the substrate. For instance, the second material can comprise a liquid, a solute dissolved in a liquid solvent, solid particles dispersed in a liquid component of the  
10 second material, or a mixture of liquid reaction components when first applied to the substrate. After the second material has been applied to the substrate, and prior to application of the curable resin to the substrate, the second material is altered to be relatively less mobile than when first applied to the substrate, so as to provide a barrier to penetration of the curable resin into predetermined portions of the  
15 substrate.

Prior to application of the curable resin to the substrate, the second material applied to the substrate is preferably transformable to be relatively immobile by, for example: increasing the viscosity of the second material; changing the phase of at least a portion of the second material from a liquid to a solid; evaporating a fluid  
20 component of the second material to provide an occlusive film or closed cell foam barrier in the substrate; or providing a chemical reaction that transforms liquid reaction components of the second material into highly viscous or solid reaction products. While Figures 4B through 4H will be discussed with reference to a second material which forms a gel, other examples of suitable second materials are provided  
25 below.

In one embodiment, the present invention includes the step of changing the phase of the second material 2000 applied to felt layer 220. The phrase "changing the phase of the second material" refers to a discontinuous change in certain properties of the second material at a definite temperature and pressure. Changing  
30 the phase of the second material includes changing a gas phase of the second material to a liquid or solid phase, changing a liquid phase of the second material to a gas phase or solid phase, and changing a solid phase of the second material to a gas or liquid phase. Examples of phase changes of the second material include, but are not limited to, liquifying the second material, subliming the second material, and  
35 solidifying the second material by freezing or gelling the second material. In one embodiment, the second material undergoes a phase change from a solid phase to a liquid phase at a temperature below the temperature at which the cured resin degrades (i.e. less than the melting temperature or the decomposition temperature of the cured resin), and more preferably at a temperature between about 50 degree  
40 Fahrenheit and about 150 degrees Fahrenheit.

5 Referring to Figure 4B, in one embodiment the second material can be applied to the felt layer 220 as a liquid mixture of water and a gelling agent at an elevated temperature. The liquid mixture of water and the gelling agent can then be allowed to cool on the felt layer 220 to form a solid gel phase of the second material which fills voids in the felt layer 220.

10 Prior to applying the photosensitive resin to the felt layer 220, it can be desirable to remove some, but not all, of the second material from felt layer 220 before applying the photosensitive resin to felt layer 220. Referring to Figure 4C, the present invention can include the step of removing second material from adjacent the first surface 230 of the felt layer 220, thereby providing a portion of the  
15 thickness of the felt layer 220 which is substantially free of the second material. Where the second material comprises a gel, a layer of the second material adjacent the first surface 230 of the felt layer 220 can be removed with a water shower 2510. Alternatively, layer of the second material can be removed from the felt layer 220 by mechanical brushing. Removing a layer of the second material adjacent the first  
20 surface 230 provides a predetermined portion of the thickness of the felt layer 220 to which the photosensitive resin can be applied and ultimately secured.

Referring to Figure 4D, the present invention includes the step of applying the curable resin to the substrate. In the embodiment shown, a layer 2010 of the liquid photosensitive resin is applied to the exposed first surface 230 of the felt layer 220  
25 after some second material is removed from the surface 230. A mask 3010 is positioned adjacent to the layer 2010 of liquid resin. The mask 3010 has opaque regions 3012 and transparent regions 3014. A nip roller 3100 controls the depth  $d$  of the layer 2010 deposited on the felt layer 220. The depth  $d$  is selected to be approximately equal to the desired difference in elevation 262 between the surface  
30 260 of the cured resin layer 250 and the felt surface 230 (Figure 4G) plus the thickness of the layer of second material 2000 removed from the felt layer in Figure 4C.

Referring to Figure 4E, the present invention includes the step of curing at least some of the resin applied to the substrate. In one embodiment of the present  
35 invention, the resin is selectively cured to provide a patterned resin layer on the substrate. In Figure 4E, resin curing lamps 3150 provide a source of actinic radiation in a first curing step for at least partially curing the layer 2010 of liquid photosensitive resin deposited on the felt layer 220. The mask 3010 is positioned intermediate the lamps 3150 and the layer 2010 of liquid photosensitive resin. The  
40 liquid photosensitive resin is selectively exposed to the actinic radiation through the mask 3010 to induce curing of the photosensitive resin in registration with the

5 transparent regions 3014 in the mask 3010. The first curing step provides a patterned resin layer 250 which is at least partially cured on the first surface 230 of the felt layer 220.

Referring to Figure 4F, the present invention can include the step of removing uncured resin from the substrate after the first curing step shown in Figure 4E. In  
10 Figure 4F, uncured resin is indicated by reference numeral 2010A. The mask 3010 can be removed from the patterned resin layer 250. The uncured resin 2010A can then be removed with water showers 2530. The water showers can be angled to remove uncured resin 2010A from the openings 270 in the patterned resin layer 250. The solidified second material 2000 prevents the uncured resin from penetrating  
15 through the full thickness of the felt layer 220, and maintains the uncured resin adjacent the first surface 230 of the felt layer 220. Accordingly, the uncured resin 2010A is relatively easy to remove from the openings 270 in the resin layer 250 with a water shower 2530. Referring to Figure 4G, the present invention includes the step of removing at least some of the second material 2000 from the substrate after the  
20 resin is applied to the substrate. In embodiments where the second material 2000 is solidified, such as by gelling, the second material 2000 can be removed by heating the second material to a temperature above its gelling temperature, thereby liquifying the gelled second material. In Figure 4G, the felt layer 220 is conveyed adjacent an infrared heating lamp 3170 positioned adjacent the first surface 230 of the felt layer  
25 220. The second material 2000 can be heated with infrared heating lamps 3170 to liquify the second material. The felt layer 220 can then be washed with a hot water shower 2550, and directed over a vacuum box 2570 to remove the liquified second material, as well as any remaining uncured photosensitive resin. In Figure 4G, the hot water shower 2550 directs a spray against the first surface 230 of the felt layer  
30 220. The vacuum box 2570 provides a vacuum at the second surface 232 of the felt layer 220 to remove liquified second material from the second surface 232. Showering and vacuuming can be repeated, as necessary, to remove the liquified second material from the felt layer 220.

Preferably, at least 50 percent of the second material 2000 applied to the  
35 substrate is removed, and most preferably substantially all of the second material 2000 applied to the substrate is removed from the substrate. As shown in Figures 4C and 4G, the second material can be removed from the substrate both before and after the liquid resin is applied to the substrate. In the embodiment shown, more of the second material is removed after application of the liquid resin to the substrate  
40 than is removed before the resin is applied to the substrate.

5 In Figures 4F and 4G, the uncured liquid resin is washed prior to removal of the second material remaining on the felt layer 220. Alternatively, all the second material 220 can be removed from the felt layer 220, followed by washing of uncured liquid resin from the felt layer 220.

10 Referring to Figure 4H, the method according to the present invention can include a post curing step performed after substantially all of the uncured liquid resin 2010A and substantially all of the second material 2000 has been removed from the felt layer 220. A source of actinic radiation, such as resin post curing lamps 3180 is positioned above the resin layer 250 to complete curing of the resin layer 250. Removal of all the second material and all the uncured liquid resin from the substrate  
15 prior to final curing of the resin layer 250 by lamps 3180 is desirable to prevent inadvertent curing of resin in portions of the felt layer 220 where permeability to air and water is desired. The post curing step can be performed with the resin layer 250 submerged in a water bath 1620 to promote complete reaction of the photosensitive resin, as described below.

20 The resulting web support apparatus 200 has a cured resin layer 250 which penetrates the first surface 230 of the felt layer 220 to extend intermediate the first and second surfaces 230 and 232. The cured resin layer 250 also extends from the first surface 230 to have a web contacting top surface 260 at a second elevation different from the elevation of the first surface 230.

25

#### Examples of Second Materials for Filing Voids in the Substrate

A number of materials are suitable for use as second material 2000 for filing voids in the substrate to prevent penetration of the liquid resin throughout the thickness of the substrate. Preferably, the second material is added to the substrate  
30 prior to application of the liquid resin to the substrate. However, in alternative embodiments the second material could be applied to a substrate to displace liquid resin that has been previously applied to the substrate. The following examples are meant to be illustrative but not limiting.

In one embodiment the second material can comprises water. Where water is  
35 used as the second material 2000, it is preferred that distilled water is used to prevent hard water deposits on the substrate. For example, water can be added to the felt layer 220 as a liquid, and maintained as a liquid throughout the steps of adding and curing the liquid photosensitive. Maintaining the water as a liquid while adding the liquid curable resin to the substrate has the disadvantage that some, if not  
40 most of the water can be displaced by the liquid resin before the resin is cured.



5           In another embodiment, water can be added to the felt layer 220 as a liquid, and then frozen prior to addition of the liquid photosensitive resin. Changing the phase of the water by freezing the water can provide a layer of ice in the felt layer that prevents penetration of the liquid resin throughout the thickness of the felt layer 220.

10           In another embodiment, the second material can be transformed to have a substantially increased viscosity as compared to its viscosity when first applied to the felt layer 220. By substantially increase the viscosity of the second material, it is meant that the viscosity of the second material increases by a factor of at least 10, and preferably at least 100. For example, the second material can comprise a solvent  
15 and a solute, such as a mixture of water and a solute component which is soluble in water. The water soluble component can comprise a water soluble resin such a polyvinyl alcohol, applied to the felt layer at an elevated temperature and low solids content. By "soluble in water" it is meant that a component is soluble in deionized water at 25 degree Centigrade at a level of at least about 1.0 percent.

20           Specifically, the second material can include an 8 percent by weight solution of Elvanol HV (available from Dupont Company, Wilmington, DL) in water. The second material can be applied to the substrate at a temperature of about 160 degrees Fahrenheit. Such a solution has a viscosity of about 250 centipoise and readily fills the voids in a felt layer 220. The concentration of the solution can be  
25 increased to about 14 percent by evaporating water, and the temperature of the solution can be decreased to about 70 degrees Fahrenheit to increase the viscosity of the second material to about 35,000 centipoise. After the photosensitive resin is applied and cured, the Elvanol can be resolubilized, preferably with hot water.

          In another embodiment, the second material can comprise a water soluble gum  
30 dissolved in water. Preferred gums show pseudoplastic behavior (shear thinning). "Shear thinning" refers to the reduction of the viscosity of a material when the material is subjected to shear forces. In one embodiment, a 1-3 percent solution of a high viscosity guar gum in water is added to the void containing substrate while the gum and water solution is subjected to a shear rate and an elevated temperature. At  
35 a shear rate in excess of about 10 reciprocal minutes and a temperature of at least about 60 degrees Centigrade the viscosity of the gum and water solution is reduced sufficiently to allow easing filling of the felt layer 220 with the gum and water solution. The shear rate on the gum and water solution is then eliminated, and the solution allowed to cool to about 70 degrees Fahrenheit to provide the gum and  
40 water solution with a viscosity greater than or equal to about 50,000 centipoise. The increased viscosity of the gum and water solution prevents displacement of the gum

5 and water solution from the felt layer 220 by the curable liquid resin. The "Handbook of Water Soluble Gums and Resins," edited by R. L. Davidson, McGraw-Hill, 1980, pp. 6-1 to 6-8 is incorporated herein by reference for the purpose of disclosing suitable water soluble gums and applying and measuring shear rates.

10 In another embodiment, the second material can comprise a mixture of water and a second component, wherein the water can be removed from the mixture, such as by drying or evaporation. For instance, the second material can be added to the felt layer 220, and the water can be removed from the second material, such as by evaporation, to provide a barrier to photosensitive resin penetration of the substrate.

15 The barrier can then be removed from the substrate by showering the substrate with water to wash the barrier from the substrate. For instance, the second material can comprise a solution of water and a high molecular weight polyvinyl alcohol plasticized with glycerol. Such a solution can be liquid at about 70 degrees Fahrenheit, and transforms into a film as the water in the solution evaporates.

20 Suitable polyvinyl alcohols include Elvanol 90-50 and Elavanol 71-30 (available from Dupont Company, Wilmington, DL). A suitable aqueous solution comprises about 6-8 percent by weight polyvinyl alcohol. Prior to mixing the polyvinyl alcohol in water, the polyvinyl alcohol can be plasticized by forming a mixture of about 90 to 95 percent polyvinyl alcohol, and about about 5 to 10 percent by weight glycerol.

25 The polyvinyl alcohol and glycerol mixture can then be added to water to form the aqueous solution comprising about 6-8 percent by weight polyvinyl alcohol.

In another embodiment, the second material can comprise a solid dispersed in a liquid. For instance, the second material can comprise a low glass transition temperature latex rubber dispersed in water. The dispersion can comprise about 40

30 percent by weight poly acrylate latex resin in water. The poly acrylate latex resin can comprise Roplex TR-520 poly acrylate latex resin available from the Rohm and Haas Company. Upon evaporation of the water in the dispersion, the solid latex spheres coalesce into a rubbery film that is easily redispersed with water provided the temperature of the film is kept below the cross-linking temperature of the latex

35 rubber. Alternatively, a blowing agent which produces a gas upon heating can be added to the dispersion. For instance, diazocarbamide can be added to the latex resin and water dispersion to produce nitrogen on heating, thereby forming a latex foam upon evaporation of the water in the dispersion.

In one embodiment, the second material can comprise a water soluble wax like

40 material, such as polyoxyethylene glycol (PEG). PEG can have a melting point below the degradation temperature of the curable photosensitive resin, such that the

5 second material is a solid at or near about 70 degrees Fahrenheit, and can be liquified  
below the degradation temperature of the curable photosensitive resin. For instance,  
a PEG having a molecular weight in excess of about 600 is suitable. More  
specifically, the second material can comprise PEG 1500 with a melting point of  
about 46 degrees C, PEG 4000 with a melting point of about 56 degrees C, PEG  
10 6000 with a melting point of about 60 degrees C, and mixtures thereof.  
Alternatively, the second material can comprise a relatively low molecular weight  
PEG, such as PEG 400, which can remain a liquid during application and curing of  
the photosensitive resin.

The second material 2000 can also comprise water soluble surfactants and  
15 water dispersible surfactant systems. For instance, the second material can comprise  
a liquid detergent solution, such as a detergent solution comprising anionic and  
nonionic surfactants, an ethyl alcohol dispensing agent, and water. The detergent  
solution can be applied to the substrate prior to application of the resin to the  
substrate. Such a detergent solution is commercially available as Joy Brand  
20 Diswashing Liquid from the Procter and Gamble Company of Cincinnati, Ohio.

The second material 2000 can also comprise a water soluble surfactant or  
water dispersible surfactant system that is a solid below about 70 degrees Fahrenheit.  
Examples of water soluble surfactants include anionic derivatives of sulfosuccinic  
acids. Applied as water solutions, these materials dry to flexible occlusive films  
25 suitable to provide a barrier to penetration of the substrate by the liquid  
photosensitive resin. An example of an anionic surfactant is Aerosol OT-75 (available  
from American Cyanamid.) Aerosol OT surfactant is a dioctyl ester of sodium  
sulfosuccinic acid.

An example of suitable water dispersible systems includes mixtures of long  
30 chain alkyl quarternary surfactants mixed with polyoxyethylene glycol 400 or  
glycerin. More specifically, a mixture of about 70 percent by weight di(tough  
hardened tallow) dimethyl ammonium chloride with about 30 percent by weight PEG  
400 (which is a pasty wax at about 70 degrees Fahrenheit and a liquid at about 150  
degrees Fahrenheit) can be used to form the second material 2000.

35 In another embodiment, the second material can comprise reaction  
components that are liquid at room temperature or are water soluble and can be  
polymerized into a higher molecular weight water soluble solid or high viscosity  
paste. For example, the second material can comprise a mixture of about 10 percent  
by weight acrylic acid, about 20 percent by weight sodium acrylate, about 70  
40 percent water, and a free radical initiator. The free radical initiator can be triggered

5 by heat. An example of a free radical initiator is V-50, a 2,2'-Azobis (2-amidino propane) dihydrochloride available from Wako Chemicals of Dallas Texas.

In another embodiment, the second material can comprise a gelling agent. Suitable gelling agents include, but are not limited to, vegetable gelling agents such as pectin, carrageenan, agar, animal protein gelatins, hydrogel forming polymeric  
10 gelling agents, and soap gelling agents. One example of a gelling agent which can be dissolved in water to form the second material 2000 is JELLO Brand gelatin from the General Foods Company of White Plains, NY.

Suitable hydrogel forming polymeric gelling agents include at least partially cross-linked polymers prepared from polymerizable, unsaturated acid-containing  
15 monomers which are water soluble or become water soluble upon hydrolysis. These include monoethylenically unsaturated compounds having at least one hydrophilic radical, including olefinically unsaturated acids and anhydrides which contain at least one carbon-carbon olefinic double bond. U.S. Patent Application 08/307,951 "Mild Gel Deodorant Composition Containing Soap, Polymeric Hydrogel Forming  
20 Polymer and High Level of Water" filed September 16, 1994 in the name of Trandai et al. is incorporated herein by reference in its entirety for the purpose of disclosing gel forming agents.

Suitable soap gelling agents comprise monovalent-metal salts of fatty acids containing from about 12 to about 40 carbon atoms (C12-C40), and more preferably  
25 C12-C22 salts of fatty acids. Suitable salt forming cations for use in these gelling agents include metal salts such as alkali metals, eg. sodium and potassium. In one embodiment the second material comprises a salt of fatty acids selected from the group consisting of sodium salts of fatty acids, potassium salts of a fatty acids, and combinations thereof.

30 Examples of fatty acids useful in synthesizing the soap gel forming agents include myristic, palmitic, stearic, oleic, linoleic, linolenic, margaric, and mixtures of such acids. Sources of such fatty acids include, but are not limited to, coconut oil, beef tallow, lanolin, fish oil, beeswax, palm oil, peanut oil, olive oil, cottonseed oil, soybean oil, corn oil, rapeseed oil, rosin acids, greases, castor oil, linseed oil, oiticica  
35 oil, neatsfoot, safflower oil, sesame oil, sorghum oil, sunflower oil, tall oil, tung oil, butter fat, poultry grease, whale oil, and rice bran.

Preferred fatty acid soap gel forming agents include sodium laurate, sodium myristate, sodium palmitate, sodium stearate, potassium laurate, potassium myristate, potassium palmitate, and potassium stearate. In one embodiment the second material  
40 2000 comprises a solution of sodium myristate in water. A suitable solution comprises between about 5 and about 30 percent by weight, and more preferably

5 between about 5 and about 20 percent by weight sodium myristate in water. Such a solution can have a gelling temperature of about 90-120 degrees Fahrenheit. The sodium myristate can be formed by reacting myristic acid ( $C_{13}H_{27}COOH$ ) with NaOH in water. The base and acid are added stoichiometrically to react completely. The NaOH is added to the water and heated to about 180 degrees Fahrenheit. The  
10 myristic acid is then gradually added to the water/NaOH solution. The reaction is continued for about an hour. The sodium myristate solution so formed is then cooled to about 140-160 degrees Fahrenheit prior to application to the felt layer 220.

Such a solution of soap gelling agent and water has the advantage that it can be solidified to a gel phase at a temperature between 50 degrees Fahrenheit and  
15 about 150 degrees Fahrenheit prior to applying the resin to the substrate. The gel phase can thereby resist displacement of the liquid photosensitive resin at room temperature (about 70 degree Fahrenheit) without requiring refrigeration equipment to provide solidification. In addition, the solution is primarily water (at least about 70 percent water by weight when added to the felt layer 220). Accordingly, removal  
20 and disposal of the second material removed from the felt layer 220 is simplified, and environmental concerns are minimized.

#### Process for Forming a Continuous Belt Having a Felt Layer and a Patterned Resin Layer

25 Figure 5 schematically illustrates a process according to one embodiment of the present invention for forming a web support apparatus 200 in the form of a continuous belt comprising a felt layer 220 having a cured resin layer 250. In the embodiment shown in Figure 5, the felt layer 220 can comprise an Amflex 2 felt commercially available from Appleton Mills of Appleton, Wisconsin, and the  
30 photosensitive resin can comprise an MEH-1000 resin commercially available from Hercules Chemical.

A forming unit 1513 in the form of a drum is provided having a working surface 1512. The forming unit 1513 is rotated by a drive means not illustrated. A backing film 1503 is provided from a roll 1531, and taken up by a roll 1532.  
35 Intermediate the rolls 1531 and 1532, the backing film 1503 is applied to the working surface 1512 of the forming unit 1513. The function of the backing film is to protect the working surface of the forming unit 1513 and to facilitate the removal of the partially completed web support apparatus 200 from the forming unit 1513. The backing film 1503 can be made of any suitable material including, but not limited  
40 to, a film of polypropylene having a thickness of between about 0.01 and about 0.1 millimeter.

5 As shown in Figure 5, the felt dewatering layer 220 in the form of a continuous belt is conveyed about forming drum 1513 and a number of return rolls 1511 in a closed path. Prior to applying the second material and the liquid resin to the felt layer 220, the felt dewatering layer 220 can be conveyed past an infrared heating lamp 2310 to preheat the felt layer 220.

10 The felt layer 220 is then conveyed in a horizontal direction at a speed of about 1-10 feet/minute adjacent a pipe header 2410 containing the second material. The header 2410 has an opening through which the second material is deposited onto the second surface 232 of the felt layer 220. The opening in the header 2410 is positioned against the the second surface 232 of the felt layer 220. The second  
15 material directed from the header 2410 is a solution of about 10 percent by weight sodium myristate in water having a temperature of about 120-150 degrees Fahrenheit.

About 0.9 grams of the second material per square inch of surface area of the felt layer 220 is deposited on the felt layer 220. The felt layer 220 on which the  
20 second material is deposited is then carried through a nip 2470 between two rollers 2472. The spacing between the rollers 2472 provides a nip which is about 0.010 inch less than the thickness of the felt layer 220. The nip 2470 ensures distribution of the second material throughout the felt layer 220 and squeezes excess second material from the felt layer 220.

25 The second material deposited on the felt layer 220 is allowed to cool to a temperature of below about 90 degrees Fahrenheit to solidify the second material. Cooling the second material results in the formation of stable gel phase of the sodium myristate in the voids of the felt layer 220. After a stable gel phase of the second material has been formed, the felt layer 220 is conveyed adjacent to a water  
30 shower 2510 at a speed of about 2-4 feet per minute. The water shower has nozzles positioned about 3 inches from the first surface 230 of the felt layer 220 for use in removal of some, but not all, of the gelled second material from the felt layer 220. The nozzles provide a plurality of fan shaped spray patterns arranged in overlapping fashion. The water showers 2510 provide a water spray of about 1.5 gallons per  
35 square foot of surface area of the felt layer 220. The nozzles are Spray Systems Tee Jet brand Nozzles, model 50015 having an orifice diameter of about 0.031 inch. The water spray delivered by the showers 2510 has a temperature of about 90 degree Fahrenheit and is delivered to the nozzles at a pressure of about 500 psig.

40 The water shower 2510 is operated to remove second material adjacent the first surface 230, to thereby provide a portion of the thickness of the felt layer 220 which is substantially free of the second material. The water showers 2510 can be

5 used to remove a layer of the gelled second material having a thickness of between about 0.002 inch and about 0.2 inch. The thickness of the layer of gelled second material removed is less than the thickness of the felt layer 220, such that between about 75 percent and about 98 percent of the thickness of the felt layer 220 remains impregnated with the gelled second material, and most preferably between about 85  
10 percent and about 95 percent of the thickness of the felt layer 220 remains impregnated with the gelled second material after washing with the water showers 2510. A vacuum header 2520 provides a vacuum of about 1-4 psig at the first surface 230 of the felt layer 220 to remove liquified second material and the water spray.

15 Once the first surface 230 of the felt layer 220 has been prepared by removal of some, but not all of the second material from the felt layer 220, the photosensitive resin can be applied to the first surface 230. The felt dewatering layer 220 is positioned adjacent the backing film 1503 such that backing film 1503 is interposed between the felt dewatering layer 220 and the forming unit 1513, and such that the  
20 second felt surface 232 of the felt dewatering layer 220 is positioned adjacent the backing film 1503. A coating of liquid photosensitive resin is applied to the first felt surface 230. The coating of liquid photosensitive resin 1502 can be applied to the first felt surface in any suitable manner. In Figure 5 the coating of resin is applied by a nozzle 1520 to form a pool of resin on the the felt layer 220 upstream of a nip  
25 formed by nip roll 3100.

The thickness of the coating of resin applied to the felt layer 220 is controlled to a preselected value corresponding to the desired difference in elevation 262 between the elevation of the first felt surface 230 and the elevation of the web contacting top surface 260 of the web patterning layer 250. In Figure 5, the  
30 thickness of the coating of resin is controlled by mechanically controlling the clearance between a nip roll 3100 and the forming unit 1513. The nip roll 3100 in conjunction with the mask 3010 and a mask guide roll 1542 tend to smooth the surface of the resin and control its thickness. The gelled second material prevents the liquid photosensitive resin from penetrating throughout the portion of the  
35 thickness of felt layer 220 occupied by the gelled second material.

The mask 3010 can be formed of any suitable material which can be provided with opaque and transparent portions. The transparent portions are arranged in a pattern corresponding to the desired pattern of the web patterning layer 250. A material in the nature of a flexible photographic film is suitable. The opaque  
40 portions can be applied to the mask 3010 in any suitable way, such as photographic, gravure, flexographic, or rotary screen printing. The mask 3010 can be an endless

5 belt, or alternatively, supplied from one supply roll 3012 and taken up by a take-up  
roll 3016, as shown in Figure 5. As shown in Figure 5, the mask 3010 is conveyed  
around the rolls 3100, 1542, 3014, and 3016. Intermediate the rolls 3100 and 1542,  
the mask 3010 travels with the felt layer 220 around the forming unit 1513, and is  
10 positioned adjacent the liquid resin, with the mask intermediate the resin and a  
source of actinic radiation which is suitable for curing the liquid resin.

The photosensitive resin is exposed to actinic radiation of an activating  
wavelength through the mask 3010, thereby inducing at least partial curing of the  
resin in those portions of the layer of resin which are in register with transparent  
portions of the mask 3010. In Figure 5, ultraviolet radiation having an activating  
15 wavelength is supplied by first curing lamps 3150. The activating wavelength is a  
characteristic of the resin, and can be supplied by any suitable source of illumination  
such as mercury arc, pulsed xenon, electrodeless, and fluorescent lamps. For the  
MEH-1000 resin, suitable curing lamps 3150 are F450 Fusion Lamps fitted with "D"  
or "H" bulbs, and commercially available from Fusion Systems, Inc. of Rockville,  
20 Md. The felt layer 220 can be conveyed adjacent the curing lamps 3150 at a speed  
of about 1-3 feet/minute during casting.

Partial curing of the resin is manifested by a solidification of the resin  
registered with the transparent portions of the mask 3010, while the unexposed  
portions of the resin registered with the opaque portions of the mask 3010 remain  
25 liquid. To obtain a uniform initial curing of the resin on the felt layer 220, the energy  
provided by the UV light to the photosensitive resin should be uniform across the  
width of the felt layer 220. Output from each of the curing lamps 3150 should be  
matched to be within at least about 5 percent of each other. The curing lamps 3150  
can be positioned side by side in the cross-machine direction (perpendicular to the  
30 plane of Figure 5.) For example, three curing lamps 3150 can be positioned side by  
side in the machine direction. A pair of aperture plates are disposed intermediate the  
lamps 3150 and the felt layer 220, and are spaced apart in the machine direction to  
form an aperture gap through which ultraviolet light is directed from the lamps 3150  
to the resin pooled on the felt layer 220.

35 Total energy directed to the felt layer 220 can be measured by a "light bug"  
such as the EIT UV Integrating Radiometer, Model Number UR365CH1 made by  
Electronic Instrumentation Technologies located in Stirling Virginia. The light bug  
can be fastened to the casting drum 1513 to measure the integrated energy in  
millijoules per square centimeter applied to the felt layer 220. By repeating this  
40 measurement every 1/2 inch across the width of the drum 1513, a profile of the  
energy imparted from the lamps 3150 to the photosensitive resin can be determined.



5 If the gap between the aperture plates is uniform along the width of the drum 1513, the energy profile will generally not be uniform. The gap between the aperture plates can be varied as a function of position in the cross-machine direction to provide a uniform energy profile delivered by the lamps 3150 to the resin pooled on the felt layer 220.

10 After partially curing the resin layer applied to the first surface 230, substantially all the uncured liquid resin can be removed from the felt dewatering layer 220. The uncured liquid resin can be removed from the felt layer 220 by high pressure showering of the felt layer 220 with water, or alternatively, a mixture of surfactant and water. At a point adjacent the roll 1542 the mask 3010 and the  
15 backing film 1503 are separated from the felt layer 220 and the partially cured resin layer. The composite felt layer 220 and partially cured resin layer are conveyed adjacent water showers 2530. The water showers 2530 can be angled to remove uncured resin 2010A from the openings in the patterned resin layer.

The showers 2530 deliver a spray at a temperature of about 60-80 degrees  
20 Fahrenheit through nozzles such as Spray Systems Tee Jet brand Nozzles, model 50015, having an orifice diameter of about 0.031 inch. The shower delivery pressure is about 500 psig. The showers 2530 and the felt layer 220 can be moved laterally (perpendicular to the plane of Figure 5) relative to one another to eliminate streaking and provide uniform removal of the liquid resin across the width of the felt layer 220.

25 The composite felt layer 220 and resin layer can then be carried through a bath 1620 of distilled or deionized water. At this point, the gelled second material is still present in the second felt layer 220. Post cure lamps 3180 positioned over the bath 1620 are turned off while the composite felt layer 220 and resin layer is carried through the bath 1620 for the first time. The post cure lamps are turned on in a final  
30 curing step described below.

After leaving the bath 1620, the composite felt layer 220 and resin layer is carried intermediate infrared heating lamps 3170 and a vacuum header 2560 at a speed of about 1-3 foot per minute. The heating lamps 3170 heat the gelled second material to a temperature of about 140 degrees Fahrenheit, which is above the  
35 gelling temperature of the second material, so that substantially all of the second material is liquified for removal from the felt layer 220. The heating lamps 3170 are positioned adjacent the first felt surface 230, and the vacuum header 2560 is positioned adjacent the second felt surface 232. The heating lamps 3170 can be positioned about 3 inches from the felt layer 220. A suitable infrared heating lamp  
40 3170 is a Protherm heating lamp manufactured by the Process Thermal Company,

5 and having a power rating of about 20 amps. The vacuum header 2560 provides a vacuum of about 1-5 psig at the second felt surface 232.

The composite felt layer and resin layer is then conveyed intermediate hot water showers 2550 and a vacuum header 2570. The hot water shower 2550 directs a spray against the first surface 230 of the felt layer 220. The showers 2550 deliver  
10 the a distilled water spray at a temperature of about 140 degrees Fahrenheit using Tee Jet brand Nozzles. The shower delivery pressure is about 50-200 psig. The vacuum header 2570 provides a vacuum of about 1-5 psig at the second surface 232 of the felt layer 220 to remove liquified second material and any remaining uncured liquid resin from the second surface 232.

15 Preferably substantially all of the second material is removed from the felt layer 220 by the heat lamps 3170, water showers 2550, and vacuum headers 2560 and 2570. If desired, the composite felt layer 220 and resin layer can be conveyed around the closed path defined by roller 1513 and rollers 1511 for multiple passes through the heat lamps 3170, water showers 2550, and vacuum headers 2560 and  
20 2570. It will be understood that if the composite felt layer 220 and resin layer is carried around the closed path multiple times to remove the second material from the felt layer 220, the multiple passes are made without adding more second material or or liquid resin to the felt layer 220, and with the ultraviolet lamps 3150 and 3180 turned off.

25 The web support apparatus 200 can be inspected with a microscope to verify that all the uncured liquid resin and second material have been removed from the felt layer 220. Alternatively, the cleanliness of the felt layer 220 can be measured using a drainage test as follows. The web support apparatus 200 can be positioned between between upper and lower Plexiglas orifice plates having 3.25 inch openings. The  
30 upper orifice plate is joined to an upstanding cylinder having an internal diameter of about 4 inches. Distilled water is added to the cylinder to maintain a column of water about 4 inches high in the cylinder. The volume of water passing through the apparatus 200 is measured for a drainage time of 1 minute. The drainage rate (cubic centimeters/sec/square foot) of the web support apparatus 200 should be generally  
35 uniform when measured at different locations on the web support apparatus 200, and should be at least about equal to the drainage rate of the felt layer 220 multiplied by the fraction of the projected area of the apparatus 200 not covered by the web patterning layer 250.

40 A final step in practicing the present invention can include a second post curing step for completing curing of the resin layer on the first surface of the felt layer 220. Once substantially all the second material and all the uncured liquid resin

5 have been removed from the felt layer 220, the composite felt layer 220 and resin  
can be conveyed through the bath 1620. Post curing lamps 3180 positioned above  
the bath 1620 provide final curing of the resin layer. The composite felt layer 220  
and resin layer are submerged in the bath 1620 which preferably contains water and a  
reducing agent, such as sodium sulfite, to remove dissolved oxygen in the water  
10 which would otherwise quench the free radical curing reaction in the bath 1620.

The composite felt layer 220 and resin layer 250 are carried through the bath  
1620 at a speed of about 1-3 feet per minute with the post curing lamps 3180 turned  
on. Suitable post curing lamps 3180 are the F450 lamps listed above. The water in  
the bath 1620 permits passage of the actinic radiation from the post curing lamp  
15 1605 to the resin layer 1521, while precluding oxygen which can quench the free  
radical polymerization reaction. The water depth in the bath 1620 can be about 1-4  
inches. After exiting the bath 1620, the composite felt layer 220 and resin layer 250  
(Figure 4H) can be carried over a vacuum header to remove water from the felt layer  
220.

20 The post curing sequence of passing the composite felt layer 220 and resin  
layer through the bath 1620 with the post curing lamp 1605 turned on can be  
repeated about 1 to 3 times until the resin layer 250 is no longer tacky. At this point,  
the felt layer 220 and the cured resin, together, form the web support apparatus 200  
having a fully cured web patterning layer 250. The post curing sequence can be  
25 repeated by carrying the composite felt layer 220 and resin layer around the circuit  
provided by the rollers 1513 and 1511 one to three times with the lamp 3150 turned  
off.

In one embodiment, the mask 1504 can be provided with a transparent portion  
in the form a continuous network. Such a mask can be used to provide the web  
30 support apparatus 200 having a web patterning layer 250 having a continuous  
network web contacting top surface 260 having a plurality of discrete openings 270  
therein, as shown in Figure 1. Each discrete opening 270 communicates with the  
first felt surface 230 through a conduit formed in the web patterning layer 250.  
Suitable shapes for the openings 270 include, but are not limited to circles, ovals  
35 elongated in the machine direction (MD shown in Figure 5), polygons, irregular  
shapes, or mixtures of these. The projected surface area of the continuous network  
top surface 260 can be between about 5 and about 75 percent of the projected area  
of the web support apparatus 200 as viewed in Figure 1, and is preferably between  
about 20 percent and about 60 percent of the projected area of the web support  
40 apparatus 200 as viewed in Figure 1.

5 In the embodiment shown in Figure 1, the continuous network top surface 260 can have less than about 700 discrete openings 270 per square inch of the projected area of the web support apparatus 200, and preferably between about 70 and about 700 discrete openings 270 therein per square inch of projected area of the web support apparatus as viewed in Figure 1. Each discrete opening 270 in the  
10 continuous network top surface can have an effective free span which is between about 0.5 and about 3.5 millimeter, where the effective free span is defined as the area of the opening 270 divided by one-fourth of the perimeter of the opening 270. The effective free span can be between about 0.6 and about 6.6 times the elevation difference 262. An apparatus having such a pattern of openings 270 can be used as a  
15 drying belt or press fabric on a papermaking machine for making a patterned paper structure having a continuous network region which can be a compacted, relatively high density region corresponding to the web contacting surface 260, and a plurality of generally uncompactd domes dispersed throughout the continuous network region, the domes corresponding to the positioning of the  
20 openings 270 in the surface 260. The discrete openings 270 are preferably bilaterally staggered in the machine direction (MD) and cross-machine direction (CD) as described in U.S. Patent 4,637,859 issued January 20, 1987, which patent is incorporated herein by reference. In the embodiment shown in Figure 1, openings 270 are over-lapping and bilaterally staggered, with the openings sized and spaced  
25 such that in both the machine and cross-machine directions the edges of the openings 270 extend past one another, and such that any line drawn parallel to either the machine or cross-machine direction will pass through at least some openings 270.

#### Measurement of Web Support Apparatus Elevations

30 The elevation difference 262 between the elevation 231 (Figure 2) of the first felt surface 230 and the elevation 261 of the web contacting surface 260 is measured using the following procedure. The web support apparatus is supported on a flat horizontal surface with the web patterning layer facing upward. A stylus having a circular contact surface of about 1.3 square millimeters and a vertical length of about  
35 3 millimeters is mounted on a Federal Products dimensioning gauge (model 432B-81 amplifier modified for use with an EMD-4320 W1 breakaway probe) manufactured by the Federal Products Company of Providence, Rhode Island. The instrument is calibrated by determining the voltage difference between two precision shims of known thickness which provide a known elevation difference. The instrument is  
40 zeroed at an elevation slightly lower than the first felt surface 230 to insure unrestricted travel of the stylus. The stylus is placed over the elevation of interest

5 and lowered to make the measurement. The stylus exerts a pressure of 0.24 grams/square millimeter at the point of measurement. At least three measurements are made at each elevation. The difference in the average measurements of the individual elevations 231 and 261 is taken as the elevation difference 262.

10 Figures 6 and 7 are photomicrographs of a web support apparatus 200 made according to the present invention. The web support apparatus 200 in Figures 6 and 7 comprises a resin layer 250 cured on a dewatering felt layer 220. The cured resin layer 250 penetrates a surface 230 of the felt layer 220, such that the cured resin layer extends into a portion of the thickness of the felt layer adjacent to the surface 230. The cured resin layer 250 also extends from the 230, such that the surface 260  
15 of the resin layer is spaced from the surface 230.

In the embodiments described above, the substrate comprises a dewatering felt layer 220. However, the method of the present invention can also be used to form patterned resin layers on other substrates. For example, the substrate can comprise a papermaking forming or drying fabric comprising woven filaments, which fabric can  
20 have an air permeability of between about 300 and about 1,500 scfm. A non-limiting example of an alternative substrate is a papermachine fabric described in the following U.S. Patents issued to Trokhan and incorporated herein by reference: U.S. Patent 4,191,609 issued March 4, 1980 and U.S. Patent 4,239,065 issued  
25 December 16, 1980.

**WHAT IS CLAIMED IS:**

1. A method of applying a photosensitive resin to a substrate, the method comprising the steps of:  
providing a substrate having a first surface, a second surface, and a thickness, the substrate having voids intermediate the first and second surfaces;  
providing a liquid photosensitive resin;  
providing a second material different from the liquid photosensitive resin;  
providing a source of actinic radiation;  
applying the second material to the substrate to occupy at least some of the voids in the substrate intermediate the first and second surfaces of the substrate;  
applying the liquid photosensitive resin to the substrate;  
exposing at least some of the liquid photosensitive resin to the actinic radiation;  
and  
curing at least some of the photosensitive resin to provide a resin layer on the substrate.
2. The method of Claim 1 further comprising the step of substantially changing the viscosity of at least some of the second material applied to the substrate before the step of curing the resin.
3. The method of Claims 1 or 2 further comprising the step of removing at least some of the second material from the substrate after applying the resin to the substrate.
4. The method of Claims 1, 2, or 3 further comprising the step of removing some, but not all, of the second material from the substrate before applying the resin to the substrate.
5. The method of Claims 1, 3, or 4 further comprising the step of changing the phase of at least some of the second material applied to the substrate before the step of curing the resin.

6. The method of Claims 1, 3, 4, or 5 further comprising the step of solidifying at least some of the second material applied to the substrate at a temperature between about 50 degrees Fahrenheit and about 150 degrees Fahrenheit prior to applying the resin to the substrate.
7. The method of Claims 1, 2, 3, 4, 5, or 6 further comprising the step of cooling at least some of the second material applied to the substrate before the step of curing the resin, and the step of heating at least some of the second material applied to the substrate before the step of removing second material from the substrate.
8. The method of Claims 1, 2, 3, 4, 5, 6, or 7 characterized in that the second material comprises water.
9. The method of Claims 1, 2, 3, 4, 5, 6, 7, or 8 characterized in that the second material comprises a component selected from the group consisting of glycerol, polyoxyethylene glycol, polyoxypropylene glycol, and combinations thereof.
10. The method of Claims 1, 2, 3, 4, 5, 6, 7, 8, or 9 characterized in that the second material comprises a gel forming agent selected from the group consisting of sodium laurate, sodium myristate, sodium palmitate, sodium stearate, potassium laurate, potassium myristate, potassium palmitate, potassium stearate, and mixtures thereof.

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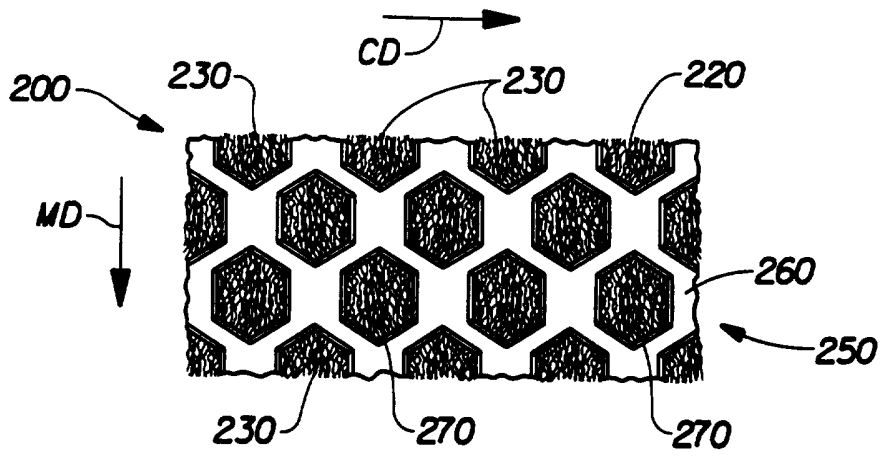


Fig. 1

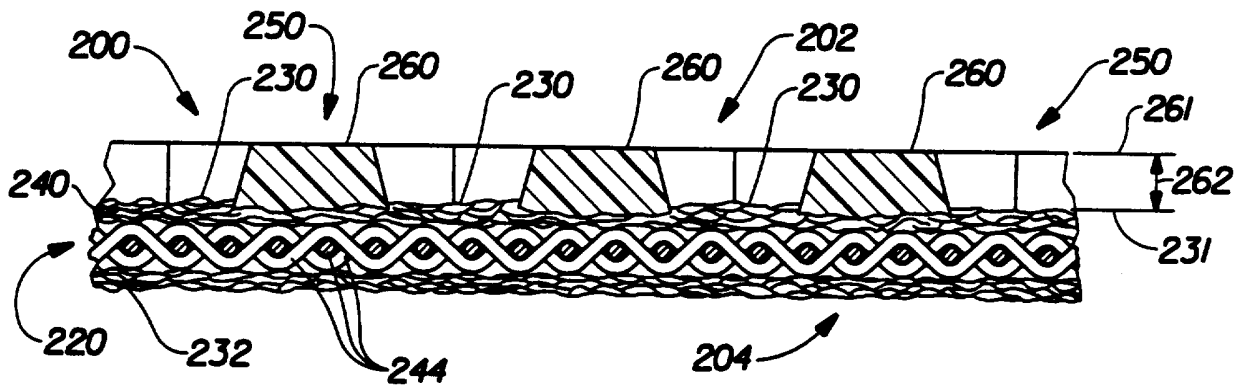


Fig. 2

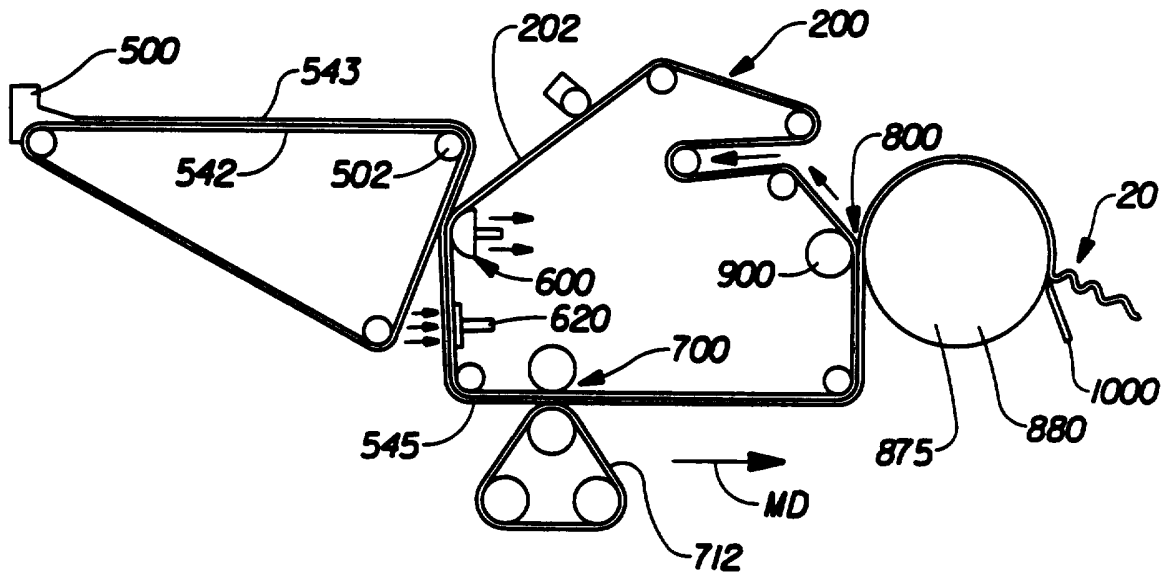


Fig. 3



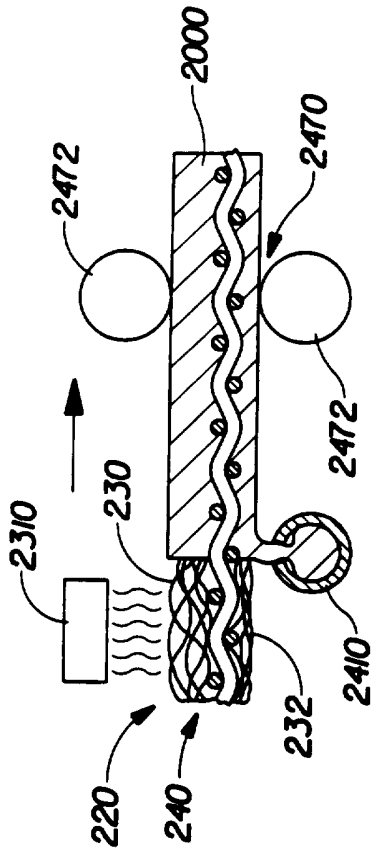


Fig. 4B

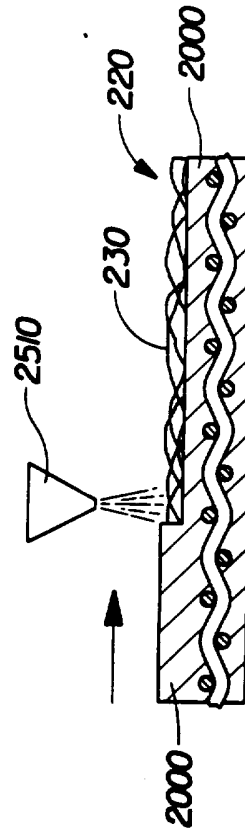


Fig. 4C

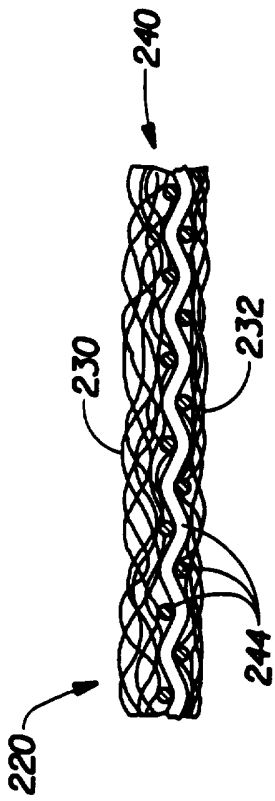


Fig. 4A

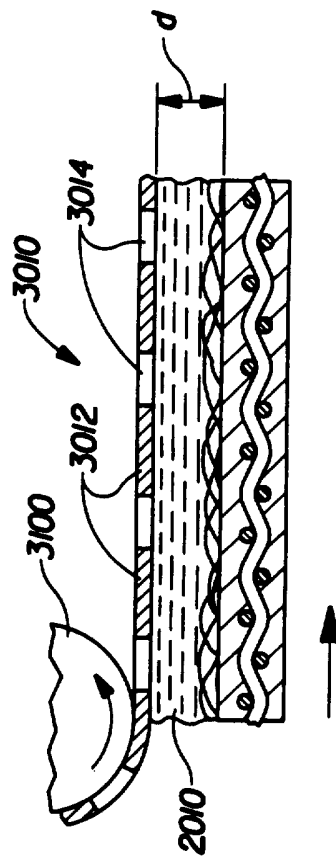


Fig. 4D

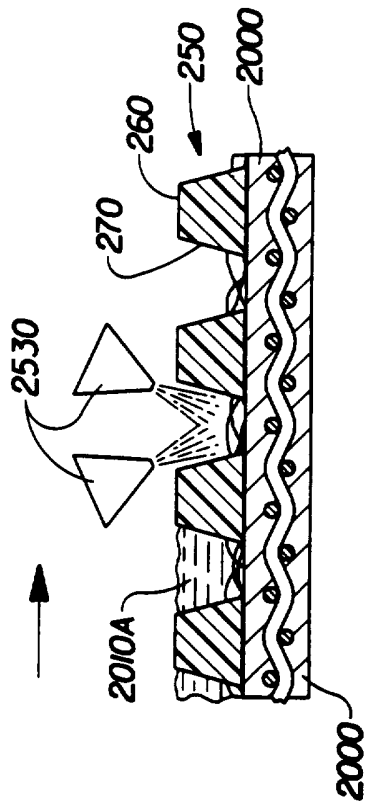


Fig. 4F

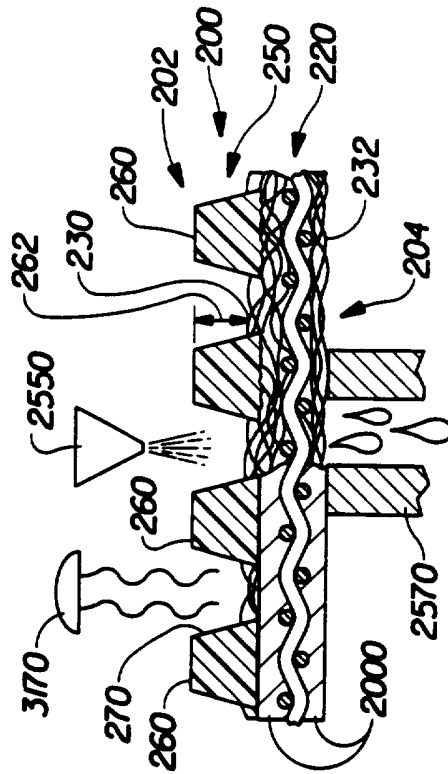


Fig. 4G

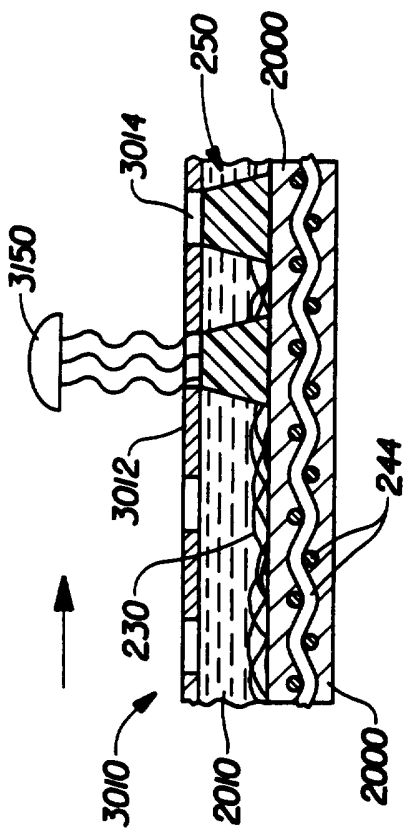


Fig. 4E

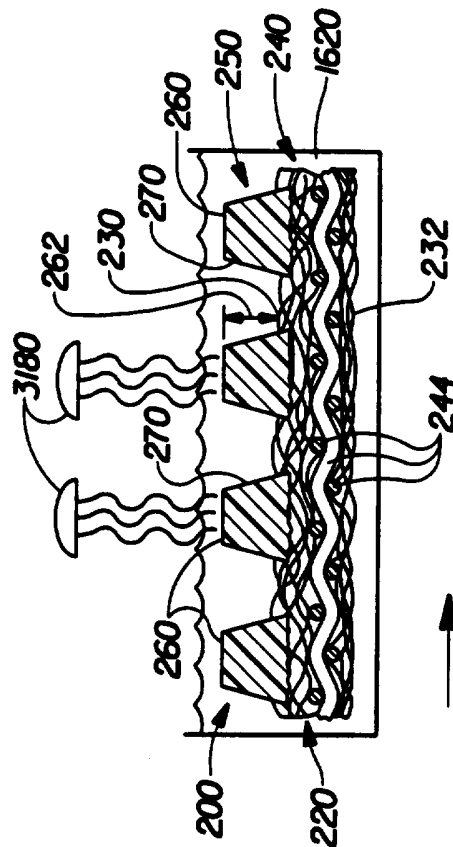


Fig. 4H



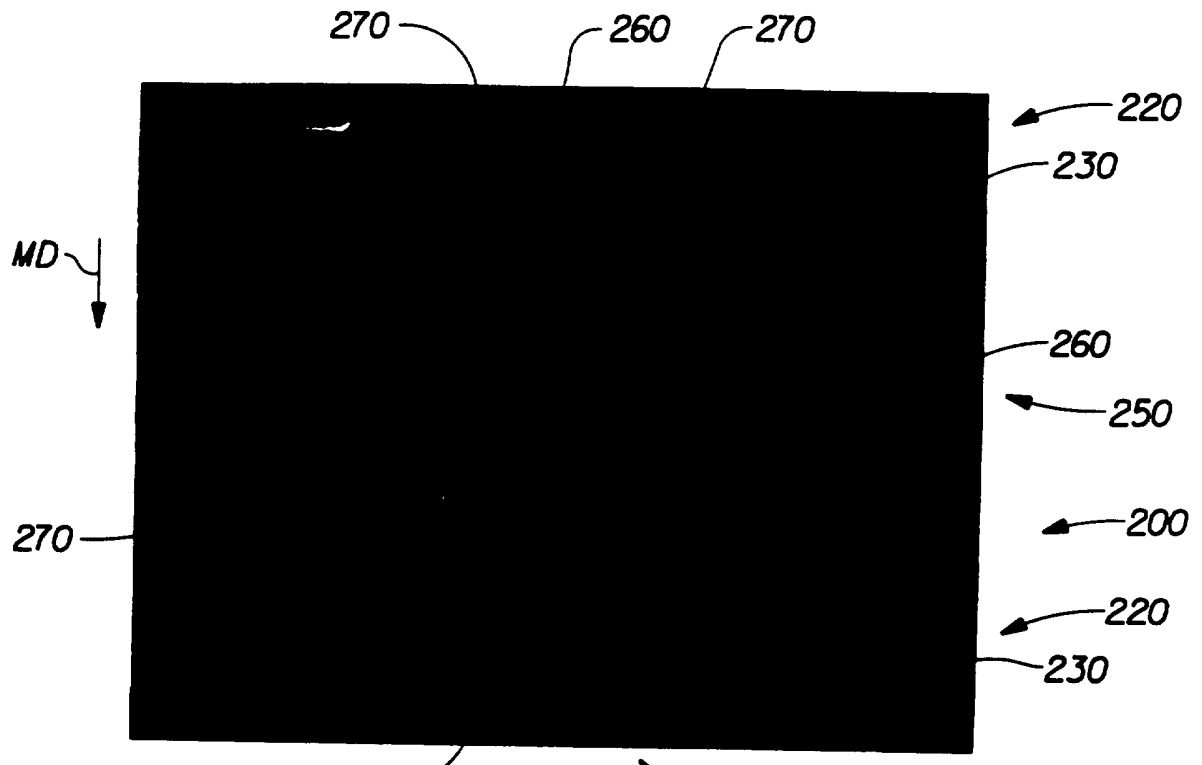


Fig. 6

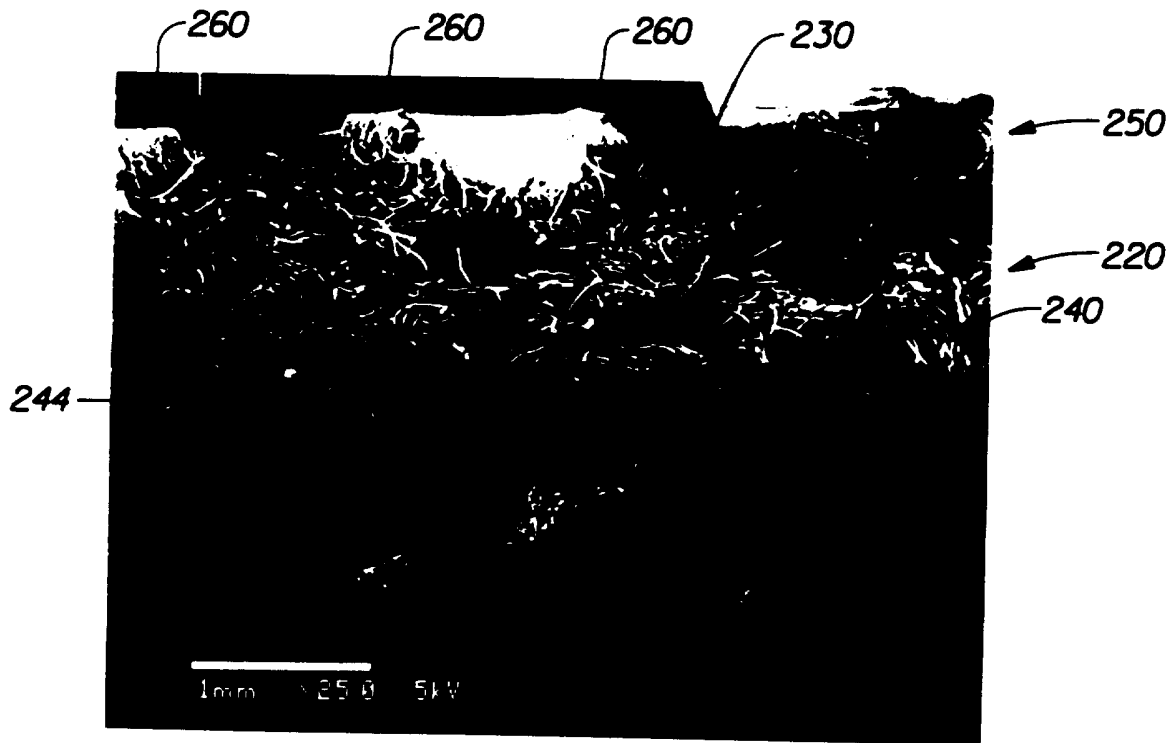


Fig. 7

# INTERNATIONAL SEARCH REPORT

Internat. Application No  
PCT/US 96/00985

**A. CLASSIFICATION OF SUBJECT MATTER**  
IPC 6 D06N3/00 B29C35/10

According to International Patent Classification (IPC) or to both national classification and IPC

**B. FIELDS SEARCHED**

Minimum documentation searched (classification system followed by classification symbols)  
IPC 6 D06N B29C

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practical, search terms used)

**C. DOCUMENTS CONSIDERED TO BE RELEVANT**

Category *	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X	DE,A,30 43 918 (FREUDENBERG CARL FA) 11 June 1981 see claim	1
A	---	
A	WO,A,91 14558 (SCAPA GROUP PLC) 3 October 1991 cited in the application see claim 1	1
A	---	
A	US,A,4 514 345 (JOHNSON BRUCE A ET AL) 30 April 1985 cited in the application see column 1, line 55 - column 2, line 32; claims; figures	1
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Further documents are listed in the continuation of box C.

Patent family members are listed in annex.

\* Special categories of cited documents :

- \*A\* document defining the general state of the art which is not considered to be of particular relevance
- \*E\* earlier document but published on or after the international filing date
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- \*O\* document referring to an oral disclosure, use, exhibition or other means
- \*P\* document published prior to the international filing date but later than the priority date claimed

- \*T\* later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention
- \*X\* document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone
- \*Y\* document of particular relevance; the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such documents, such combination being obvious to a person skilled in the art.
- \*A\* document member of the same patent family

Date of the actual completion of the international search

29 May 1996

Date of mailing of the international search report

14 -06- 1996

Name and mailing address of the ISA

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Authorized officer

Pamies Ollé, S

# INTERNATIONAL SEARCH REPORT

Internat. Application No  
PCT/US 96/00985

C.(Continuation) DOCUMENTS CONSIDERED TO BE RELEVANT		
Category *	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
A	WO,A,92 00414 (PROCTER & GAMBLE) 9 January 1992 cited in the application see claims <p style="text-align: center;">-----</p>	1

1

INTERNATIONAL SEARCH REPORT

International Application No  
PCT/US 96/00985

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WO-A-9114558	03-10-91	GB-A- 2241915	18-09-91
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US-A-4514345	30-04-85	NONE	
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